

Product Summary

| V _{RRM} (V) | I _O (A) | V _F MAX(V) @+25°C | I _R MAX(mA) @ +25°C |
|----------------------|--------------------|------------------------------|--------------------------------|
| 60 | 20 | 0.79 | 0.5 |

Description and Applications

This Super Barrier Rectifier (SBR) diode has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as a :

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

Features and Benefits

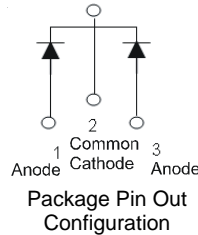
- 100% Avalanche tested.
- Patented SBR technology provides a superior avalanche capability than schottky diodes ensuring more rugged and reliable end applications.
- Reduced Ultra-low forward voltage drop (V_F); better efficiency and cooler operation.
- Reduced high temperature reverse leakage; Increased reliability against thermal runaway failure in high temperature operation.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: TO263 (D²PAK)
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 1.6 grams (approximate)



TO263
Top View

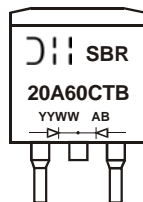


Ordering Information (Notes 4)

| Part Number | Compliance | Case | Packaging |
|-----------------|------------|-------|-----------------|
| SBR20A60CTBQ-13 | Automotive | TO263 | 800/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



SBR20A60CTB = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last two digits of year (ex: 13 = 2013)
 WW = Week (01 - 53)

Maximum Ratings (Per Leg) (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------|------|
| Peak Repetitive Reverse Voltage | V _{RRM} | 60 | V |
| Working Peak Reverse Voltage | V _{RWM} | | |
| DC Blocking Voltage | V _{RM} | | |
| Average Rectified Output Current Per Device | I _O | 20 | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | 180 | A |
| Peak Repetitive Reverse Surge Current (2μS - 1Khz) | I _{RRM} | 3 | A |
| Repetitive Peak Avalanche Power (1μs, +25°C) | P _{ARM} | 7000 | W |
| Non-Repetitive Avalanche Energy (T _J = +25°C, I _{AS} = 12A L = 10mH) | E _{AS} | 500 | mJ |

Thermal Characteristics (Per Leg)

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Typical Thermal Resistance | R _{θJC} | 4 | °C/W |
| Thermal Resistance Junction to Case (Note 5) | R _{θJA} | 8 | |
| Thermal Resistance Junction to Ambient (Note 5) | | | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Electrical Characteristics (Per Leg) (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|--------------------------|----------------|-----|------|------|------|---|
| Forward Voltage Drop | V _F | — | 0.50 | — | V | I _F = 10A, T _J = +25°C |
| | | — | 0.47 | — | | I _F = 10A, T _J = +125°C |
| | | — | 0.63 | 0.79 | | I _F = 20A, T _J = +25°C |
| Leakage Current (Note 6) | I _R | — | 0.14 | 0.5 | mA | V _R = 60V, T _J = +25°C |
| | | — | 45 | — | | V _R = 60V, T _J = +125°C |

Notes: 5. Mounted heatsink black Aluminum, 45mm*20mm*12mm, minimum recommended pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com>.
6. Short duration pulse test used to minimize self-heating effect.

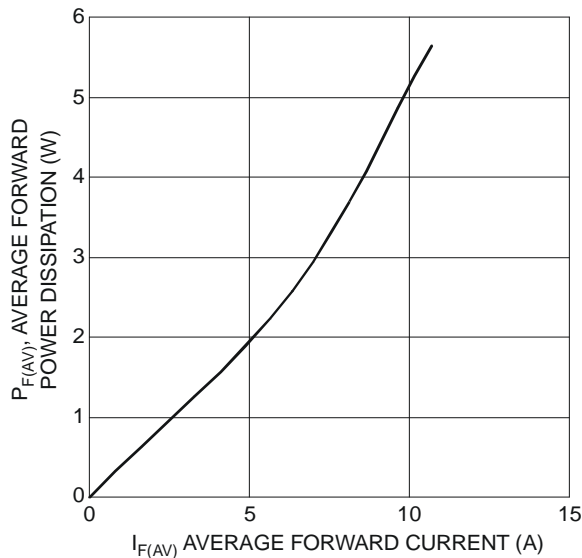


Figure 1 Forward Power Dissipation

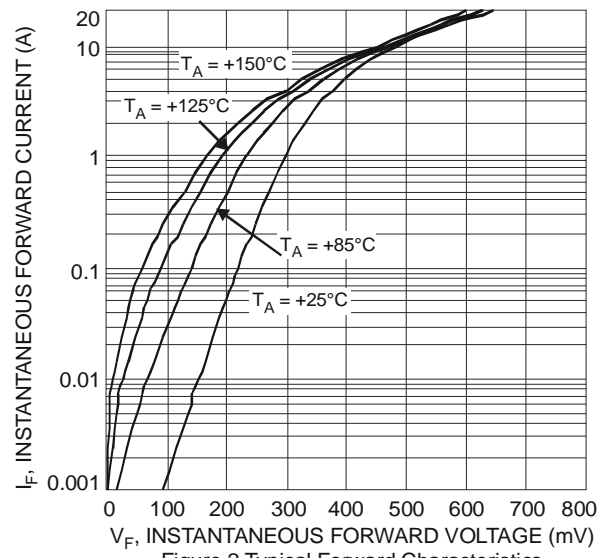


Figure 2 Typical Forward Characteristics

Note: 7. Mounted heatsink, black Aluminum, 45mm*20mm*12mm, min recommended pad layout layout.

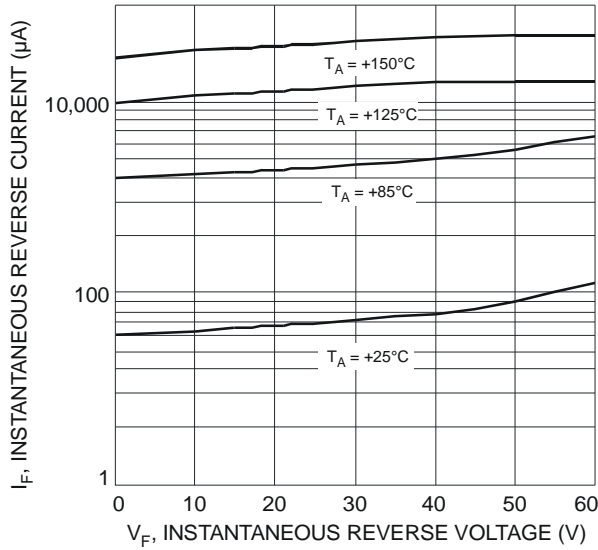


Figure 3 Typical Reverse Characteristics

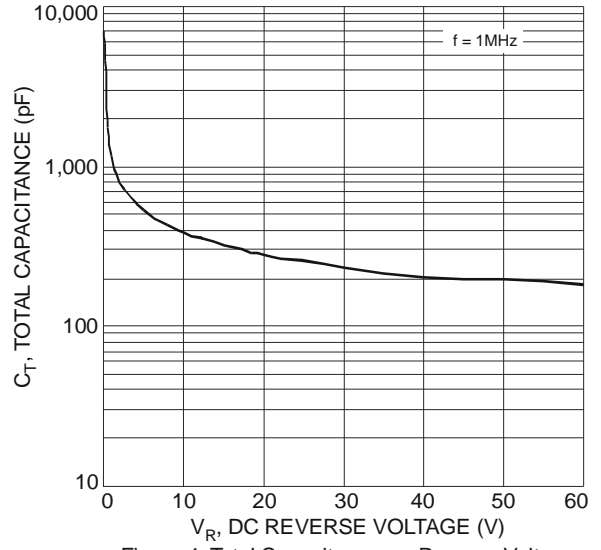


Figure 4 Total Capacitance vs. Reverse Voltage

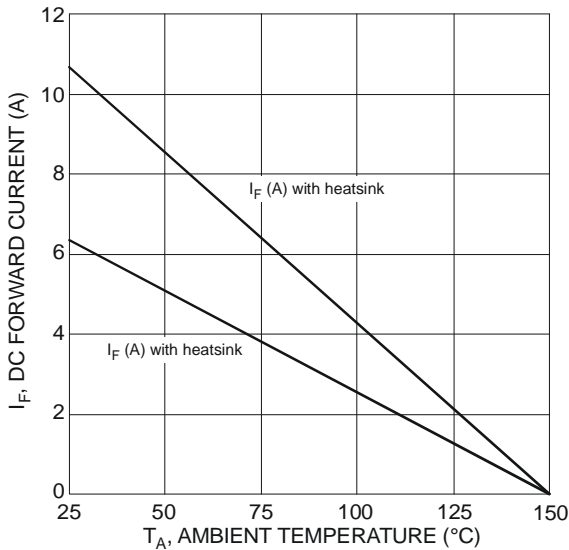


Figure 5 Forward Current Derating Curve

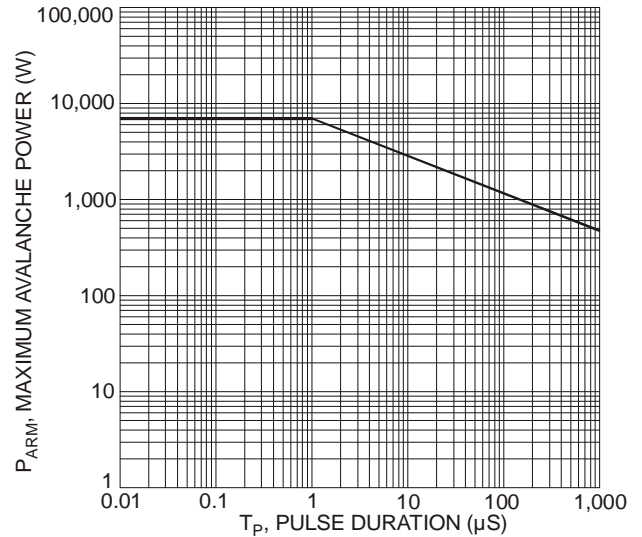


Figure 6 Maximum Avalanche Power Curve

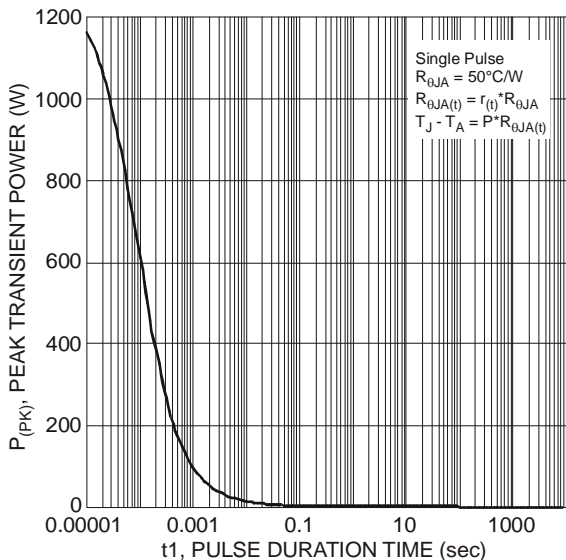
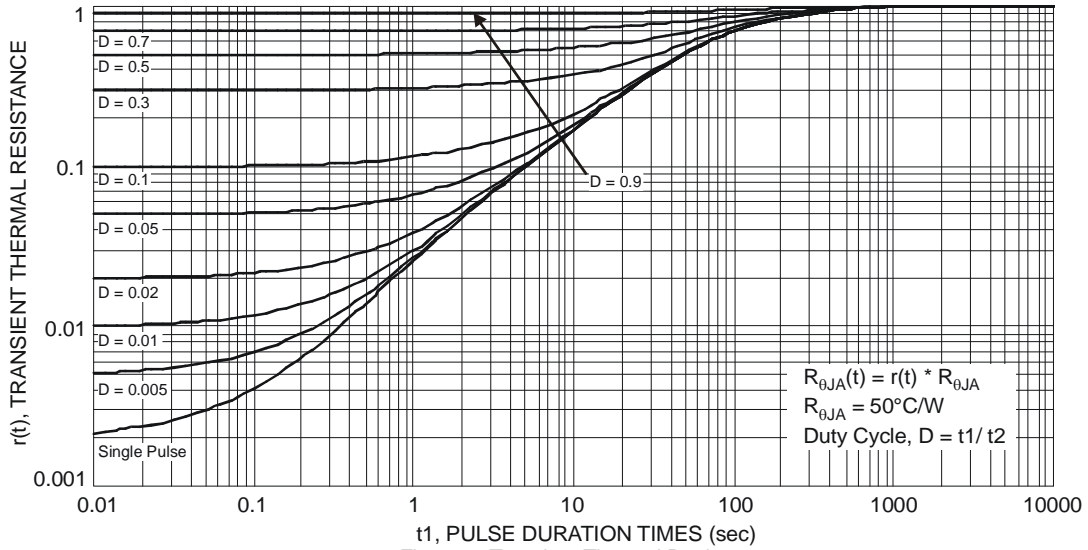
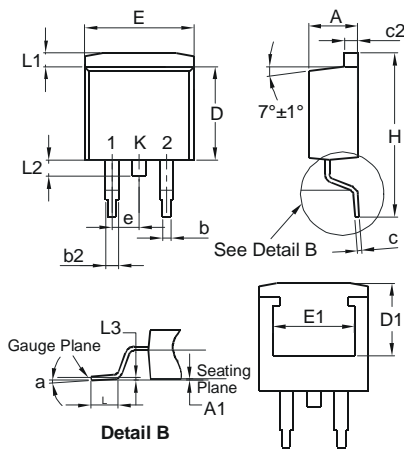


Figure 7 Single Pulse Maximum Power Dissipation



Package Outline Dimensions

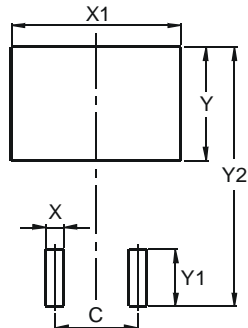
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| TO263 | | |
|-----------------------------|----------|-------|
| Dim | Min | Max |
| A | 4.07 | 4.82 |
| A1 | 0.00 | 0.25 |
| b | 0.51 | 0.99 |
| b2 | 1.15 | 1.77 |
| c | 0.356 | 0.73 |
| c2 | 1.143 | 1.65 |
| D | 8.39 | 9.65 |
| D1 | 6.55 | — |
| E | 9.66 | 10.66 |
| E1 | 6.23 | — |
| e | 2.54 Typ | |
| H | 14.61 | 15.87 |
| L | 1.78 | 2.79 |
| L1 | — | 1.67 |
| L2 | — | 1.77 |
| a | 0° | 8° |
| All Dimensions in mm | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 5.08 |
| X | 1.10 |
| X1 | 10.41 |
| Y | 3.50 |
| Y1 | 7.01 |
| Y2 | 15.99 |

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